imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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MCD224-22io1

V

Α V

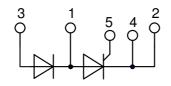
High Voltage Thyristor \ Diode Module	V_{RRM}	= 2 2	x 2200 '
3	I _{tav}	=	250
	Vτ	=	1.03

Phase leg

Part number MCD224-22io1



Backside: isolated **E**72873



Features / Advantages:

- Thyristor for line frequency
- Planar passivated chip
- Long-term stability
- Direct Copper Bonded Al2O3-ceramic

Applications:

- Line rectifying 50/60 Hz
- Softstart AC motor control
- DC Motor control
- Power converter
- AC power control
- Lighting and temperature control

Package: Y1

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Base plate: Copper
- internally DCB isolated
- Advanced power cycling

Terms Conditions of usage:

The data contained in this product data sheet is exclusively intended for technically trained staff. The user will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to his application. The specifications of our components may not be considered as an assurance of component characteristics. The information in the valid application and assembly notes must be considered. Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of your product, please contact your local sales office. Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact your local sales office. Should you intend to use the product in aviation, in health or life endangering or life support applications, please notify. For any such application we urgently recommend

to perform joint risk and quality assessments;
the conclusion of quality agreements;

- to establish joint measures of an ongoing product survey, and that we may make delivery dependent on the realization of any such measures.

IXYS reserves the right to change limits, conditions and dimensions.

Data according to IEC 60747and per semiconductor unless otherwise specified

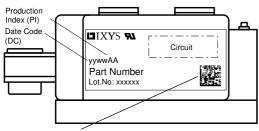
MCD224-22io1

Rectifier					Ratings	I	
Symbol	Definition	Conditions		min.	typ.	max.	Uni
V _{RSM/DSM}	max. non-repetitive reverse/forwa	ard blocking voltage	$T_{VJ} = 25^{\circ}C$			2300	`
V _{RRM/DRM}	max. repetitive reverse/forward bl		$T_{VJ} = 25^{\circ}C$			2200	١
R/D	reverse current, drain current	V _{R/D} = 2200 V	$T_{vJ} = 25^{\circ}C$			1	m/
		V _{R/D} = 2200 V	$T_{vJ} = 140^{\circ}C$			40	mA
VT	forward voltage drop	$I_{T} = 250 \text{ A}$	$T_{VJ} = 25^{\circ}C$			1.08	١
		$I_{T} = 500 \text{ A}$				1.31	١
		$I_{T} = 250 \text{ A}$	$T_{VJ} = 125 \degree C$			1.03	١
		$I_{T} = 500 \text{ A}$				1.33	١
I _{tav}	average forward current	$T_c = 85^{\circ}C$	T _{vJ} = 140°C			250	ļ
I _{T(RMS)}	RMS forward current	180° sine				390	ļ
V _{T0}	threshold voltage		T _{v.i} = 140°C			0.72	١
r _T	slope resistance } for power lo	oss calculation only	**			1.2	m۵
R thJC	thermal resistance junction to cas	Se .				0.139	K/W
R _{thCH}	thermal resistance case to heatsi				0.040		K/W
P _{tot}	total power dissipation		$T_c = 25^{\circ}C$		0.0.0	820	W
I _{TSM}	max. forward surge current	t = 10 ms; (50 Hz), sine	$T_{v,l} = 45^{\circ}C$			8.00	k/
TSM	max formard barge barronk	t = 8,3 ms; (60 Hz), sine	$V_{\rm NJ} = -43$ C $V_{\rm R} = 0$ V			8.64	k/
		t = 0.3 ms; (50 Hz), sine t = 10 ms; (50 Hz), sine	$\frac{V_{R} = 0.V}{T_{V,I} = 140^{\circ}C}$			6.80	k/
101	value for fueing	t = 8,3 ms; (60 Hz), sine	$\frac{V_{R} = 0 V}{T_{R} + 1000}$			7.35	k/
l²t	value for fusing	t = 10 ms; (50 Hz), sine	$T_{VJ} = 45^{\circ}C$			320.0	kA ²
		t = 8,3 ms; (60 Hz), sine	$V_{\rm R} = 0 V$			310.5	kA ²
		t = 10 ms; (50 Hz), sine	$T_{VJ} = 140 ^{\circ}\text{C}$			231.2	kA ²
		t = 8,3 ms; (60 Hz), sine	$V_R = 0 V$			224.4	¦
C	junction capacitance	$V_{R} = 700 V f = 1 MHz$	$T_{VJ} = 25^{\circ}C$		235		pl
P _{GM}	max. gate power dissipation	t _P = 30 μs	$T_c = 140 °C$			120	N
		t _P = 500 μs				60	N
P _{GAV}	average gate power dissipation					20	N
(di/dt) _{cr}	critical rate of rise of current	$T_{VJ} = 125 ^{\circ}C; f = 50 Hz$ re	epetitive, $I_{T} = 750 \text{ A}$			100	A/μ
		t_{P} = 200 µs; di_{G}/dt = 1 A/µs; -					
		$I_{G} = 1 \text{ A}; \text{ V} = \frac{2}{3} \text{ V}_{DRM}$ n	on-repet., $I_{T} = 250 \text{ A}$			500	A/μ
(dv/dt) _{cr}	critical rate of rise of voltage	$V = \frac{2}{3} V_{DBM}$	T _{vJ} = 125°C			1000	V/µ
		$R_{GK} = \infty$; method 1 (linear volta	ige rise)				
V _{gt}	gate trigger voltage	$V_{\rm p} = 6 \text{ V}$	$T_{v,l} = 25^{\circ}C$			2	١
- 01			$T_{v,i} = -40 ^{\circ}\text{C}$			3	١
I _{GT}	gate trigger current	$V_D = 6 V$	$T_{VJ} = 25^{\circ}C$			150	m/
GI	gale lingger earrent	• <u> </u>	$T_{VJ} = -40^{\circ}C$			220	m/
V _{gd}	gate non-trigger voltage	$V_{D} = \frac{2}{3} V_{DBM}$	$T_{VJ} = -40^{\circ} \text{C}$ $T_{VJ} = 140^{\circ} \text{C}$			0.25	۱۱۱/
		$\mathbf{v}_{\mathrm{D}} = 73 \mathbf{v}_{\mathrm{DRM}}$	1 _{VJ} = 140 O			10	
I _{GD}	gate non-trigger current		T 0500				m/
I.	latching current	$t_p = 30 \ \mu s$	$T_{vJ} = 25 ^{\circ}C$			200	m/
		$I_{\rm G} = 0.45 \rm{A}; di_{\rm G}/dt = 0.45 \rm{A}/\mu s$				450	
I _H	holding current	$V_{\rm D} = 6 V R_{\rm GK} = \infty$	$T_{VJ} = 25 \degree C$			150	m/
t _{gd}	gate controlled delay time	$V_D = \frac{1}{2} V_{DRM}$	$T_{VJ} = 25 \degree C$			2	μ
		$I_{\rm G} = 0.5 \text{A}; \text{di}_{\rm G}/\text{dt} = 0.5 \text{A}/\mu\text{s}$					
t _q	turn-off time	$V_{\rm R} = 100 \text{ V}; I_{\rm T} = 250 \text{ A}; \text{ V} = \frac{2}{3}$	∕γ V T 125 °C		350	1	μ

 $\ensuremath{\mathsf{IXYS}}$ reserves the right to change limits, conditions and dimensions.

MCD224-22io1

Package Y1			F	Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit
	RMS current	per terminal				600	Α
T _{vj}	virtual junction temperature			-40		140	°C
T _{op}	operation temperature			-40		125	°C
T _{stg}	storage temperature			-40		125	°C
Weight					680		g
M _D	mounting torque			4.5		7	Nm
M _T	terminal torque			11		13	Nm
d _{Spp/App}	creepage distance on surface striking distance through air		terminal to terminal	16.0			mm
d _{Spb/Apb}	creepage ustance on surface / surking	g distance through an	terminal to backside	16.0			mm
V	isolation voltage	t = 1 second		3600			V
	t = 1 minute	50/60 Hz, RMS; liso∟ ≤ 1 mA	3000			V	



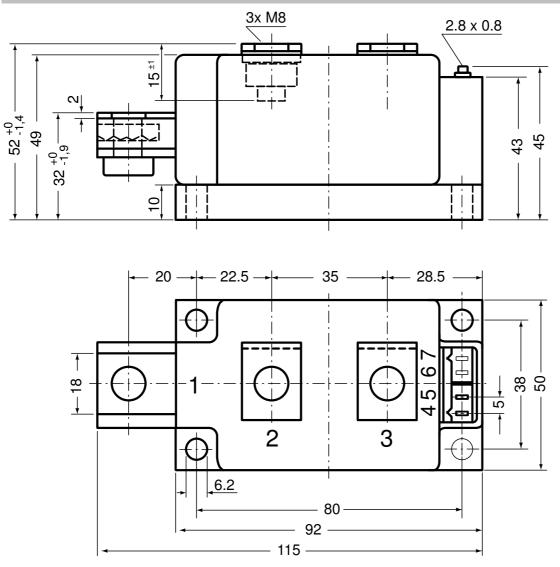
Data Matrix: part no. (1-19), DC + PI (20-25), lot.no.# (26-31), blank (32), serial no.# (33-36)

Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	MCD224-22io1	MCD224-22io1	Box	3	479101

Equiva	alent Circuits for	Simulation	* on die level	T _{vj} = 140 °C
)R	Thyristor		
V _{0 max}	threshold voltage	0.72		V
$\mathbf{R}_{0 \max}$	slope resistance *	1.01		mΩ

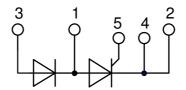
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Outlines Y1

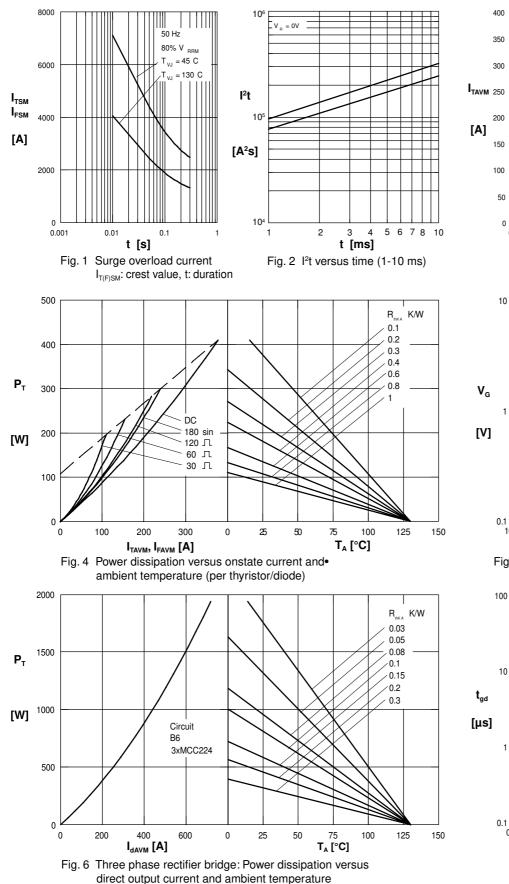


Optional accessories for modules

Keyed gate/cathode twin plugs with wire length = 350 mm, gate = white, cathode = red Type ZY 180L (L = Left for pin pair 4/5) Type ZY 180R (R = Right for pin pair 6/7) UL 758, style 3751



Thyristor



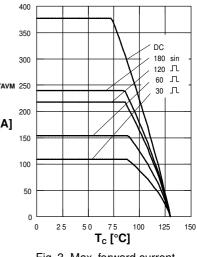


Fig. 3 Max. forward current at case temperature

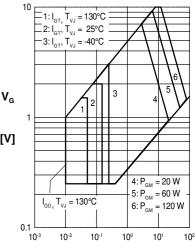
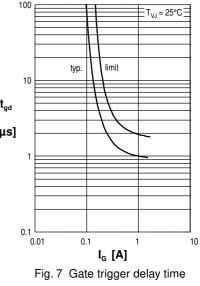
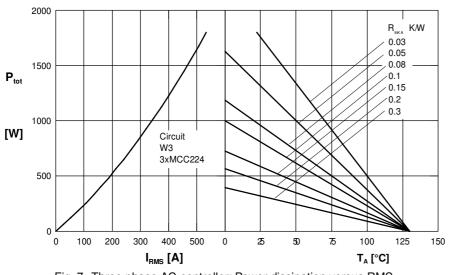


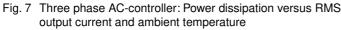
Fig. 5 Gate trigger characteristics

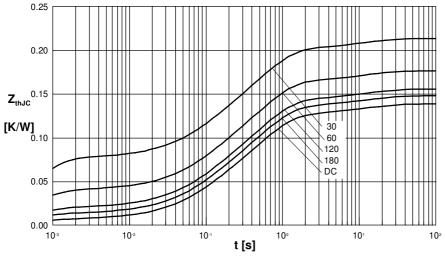


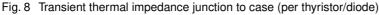
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Rectifier









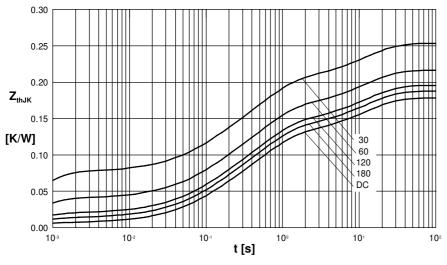
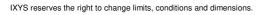


Fig. 9 Transient thermal impedance junction to heatsink (per thyristor/diode)



600 500 400 I_T 300 [A] $T_{VJ} = 125^{\circ}C$ 200 100 T_{VJ} = 25°C 0 0.5 1.0 1.5 V_ [V] Fig. 10 Forward characteristics

 R_{thJC} for various conduction angles d:

d	R _{thJC} [K/W]
DC	0.139
180°C	0.148
120°C	0.156
60°C	0.176
30°C	0.214

Constants for Z_{thJC} calculation:

i	R _{thi} [K/W]	t _i [s]
1	0.0067	0.00054
2	0.0358	0.098
3	0.0832	0.540
4	0.0129	12.00

 $R_{\mbox{\tiny thJK}}$ for various conduction angles d:

d	R _{thJK} [K/W]
DC	0.179
180°C	0.188
120°C	0.196
60°C	0.216
30°C	0.256

Constants for Z_{thJK} calculation:

i	R _{thi} [K/W]	t _i [s]
1	0.0067	0.001
2	0.0358	0.080
3	0.0832	0.200
4	0.0129	1.000